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# FAN5350

## 3MHz, 600mA Step-Down DC-DC Converter in Chip-Scale and MLP Packaging

### Features

- 3MHz Fixed-Frequency Operation
- 16µA Typical Quiescent Current
- 600mA Output Current Capability
- 2.7V to 5.5V Input Voltage Range
- 1.82V Fixed Output Voltage
- Synchronous Operation
- Power-Save Mode
- Soft-Start Capability
- Input Under-Voltage Lockout (UVLO)
- Thermal Shutdown and Overload Protection
- 6-Lead 3 x 3mm MLP
- 5-Bump 1 x 1.37mm WLCSP

### Applications

- Cell Phones, Smart-Phones
- Pocket PCs
- WLAN DC-DC Converter Modules
- PDA, DSC, PMP, and MP3 Players
- Portable Hard Disk Drives


### Description

The FAN5350 is a step-down switching voltage regulator that delivers a fixed 1.82V from an input voltage supply of 2.7V to 5.5V. Using a proprietary architecture with synchronous rectification, the FAN5350 is capable of delivering 600mA at over 90% efficiency, while maintaining a very high efficiency of over 80% at load currents as low as 1mA. The regulator operates at a nominal fixed frequency of 3MHz at full load, which reduces the value of the external components to 1µH for the output inductor and 4.7µF for the output capacitor.

At moderate and light loads, pulse frequency modulation is used to operate the device in power-save mode with a typical quiescent current of 16µA. Even with such a low quiescent current, the part exhibits excellent transient response during large load swings. At higher loads, the system automatically switches to fixed-frequency control, operating at 3MHz. In shutdown mode, the supply current drops below 1µA, reducing power consumption.

The FAN5350 is available in a 6-lead Molded Leadless Package (MLP) and a 5-bump Wafer Level Chip Scale Package (WLCSP).

### Ordering Information

Part Number	Operating Temperature Range	Package	 Eco Status	Packing Method
FAN5350UCX	-40°C to 85°C	5-Ball, Type-1 WL-CSP, 1x1.37mm, .5mm Pitch	Green	Tape and Reel
FAN5350MPX	-40°C to 85°C	6-Lead, Molded Leadless Package (MLP), Dual, JEDEC MO-229, 3mm Square, Extended DAP	Green	Tape and Reel

 For Fairchild's definition of Eco Status, please visit: [http://www.fairchildsemi.com/company/green/rohs\\_green.html](http://www.fairchildsemi.com/company/green/rohs_green.html). Please refer to tape and reel specifications at [www.fairchildsemi.com](http://www.fairchildsemi.com); <http://www.fairchildsemi.com/packaging>.

### Typical Applications

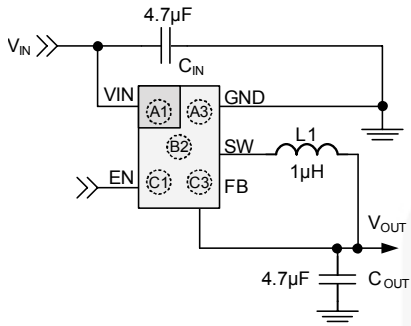


Figure 1. WLCSP, Bumps Facing Down

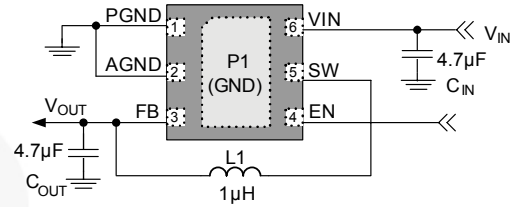


Figure 2. MLP, Leads Facing Down

### Block Diagram

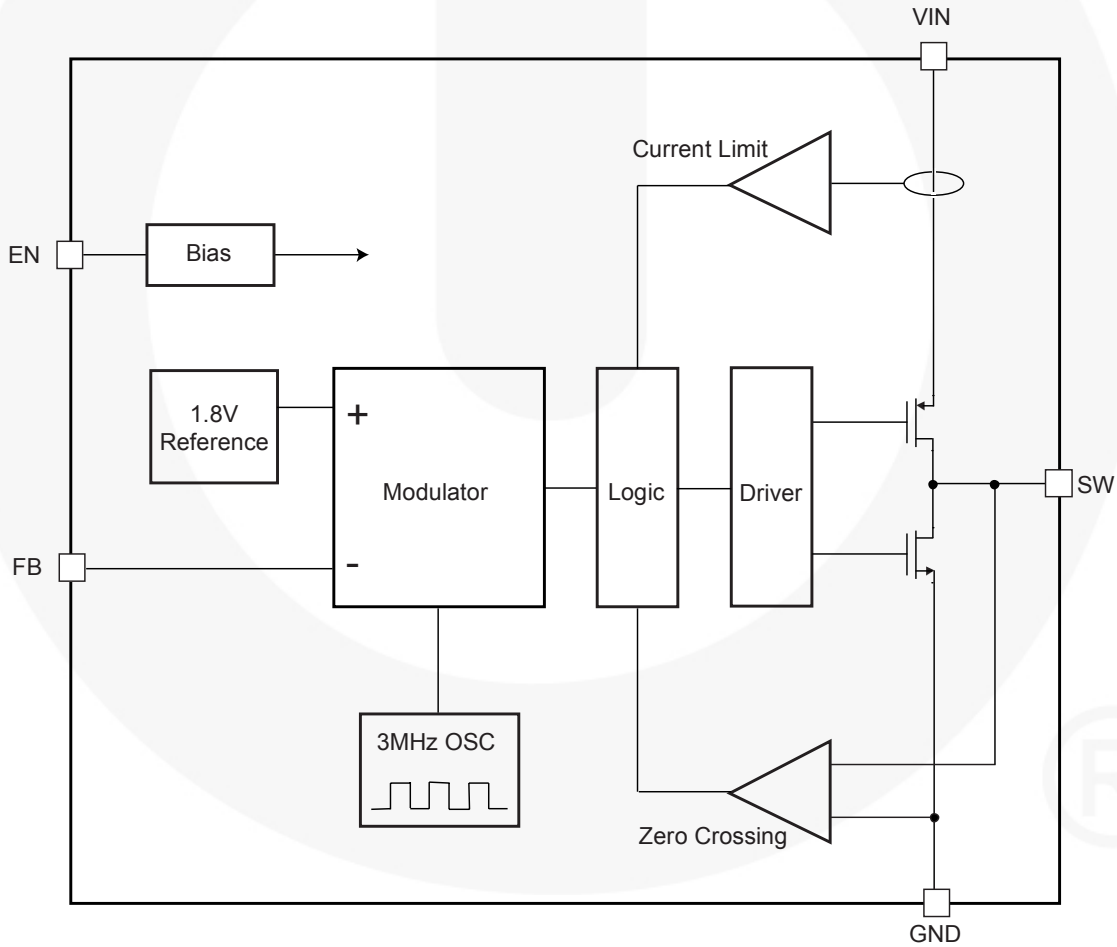


Figure 3. Block Diagram

## Pin Configurations

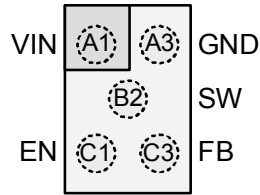


Figure 4. WLCSP - Bumps Facing Down

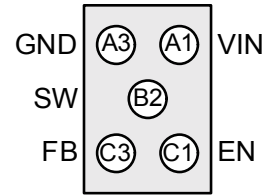


Figure 5. WLCSP - Bumps Facing Up

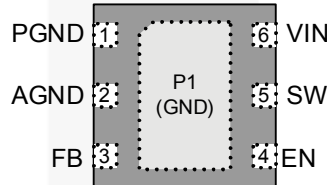


Figure 6. 3x3mm MLP - Leads Facing Down

## Pin Definitions

### WLCSP

Pin #	Name	Description
A1	V <sub>IN</sub>	<b>Power Supply Input.</b>
A3	GND	<b>Ground Pin.</b> Signal and power ground for the part.
C1	EN	<b>Enable Pin.</b> The device is in shutdown mode when voltage to this pin is <0.4V and enabled when >1.2V. Do not leave this pin floating.
C3	FB	<b>Feedback Analog Input.</b> Connect directly to the output capacitor.
B2	SW	<b>Switching Node.</b> Connection to the internal PFET switch and NFET synchronous rectifier.

### MLP

Pin #	Name	Description
1	PGND	<b>Power Ground Pin.</b> Power stage ground. Connect PGND and AGND together via the board ground plane.
2	AGND	<b>Analog Ground Pin.</b> Signal ground for the part.
3	FB	<b>Feedback Analog Input.</b> Connect directly to the output capacitor.
4	EN	<b>Enable Pin.</b> The device is in shutdown mode when voltage to this pin is <0.4V and enabled when >1.2V. Do not leave this pin floating.
5	SW	<b>Switching Node.</b> Connection to the internal PFET switch and NFET synchronous rectifier.
6	V <sub>IN</sub>	<b>Power Supply Input.</b>

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V <sub>IN</sub>	Input Voltage with respect to GND		-0.3	6.0	V
	Voltage on any other pin with respect to GND		-0.3	V <sub>IN</sub>	V
T <sub>J</sub>	Junction Temperature		-40	+150	°C
T <sub>STG</sub>	Storage Temperature		-65	+150	°C
T <sub>L</sub>	Lead Temperature (Soldering 10 Seconds)			+260	°C
ESD	Electrostatic Discharge Protection Level	Human Body Model	4.5		kV
		Charged Device Model	MLP	1.5	
			WLCSP	2.0	
		Machine Model	200		V

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Typ.	Max.	Unit
V <sub>CC</sub>	Supply Voltage Range	2.7		5.5	V
I <sub>OUT</sub>	Output Current	0		600	mA
L	Inductor	0.7	1.0	3.0	μH
C <sub>IN</sub>	Input Capacitor	3.3	4.7	12.0	μF
C <sub>OUT</sub>	Output Capacitor	3.3	4.7	12.0	μF
T <sub>A</sub>	Operating Ambient Temperature	-40		+85	°C
T <sub>J</sub>	Operating Junction Temperature	-40		+125	°C

## Thermal Properties

Symbol	Parameter	Min.	Typ.	Max.	Units
Θ <sub>JA_WLCSP</sub>	Junction-to-Ambient Thermal Resistance <sup>(1)</sup>		180		°C/W
Θ <sub>JA_MLP</sub>	Junction-to-Ambient Thermal Resistance <sup>(1)</sup>		49		°C/W

### Note:

- Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four-layer 1s2p boards in accordance to JESD51- JEDEC standard. Special attention must be paid not to exceed junction temperature T<sub>J(max)</sub> at a given ambient temperature T<sub>A</sub>.

## Electrical Characteristics

Minimum and maximum values are at  $V_{IN} = 2.7V$  to  $5.5V$ ,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ ,  $C_{IN} = C_{OUT} = 4.7\mu F$ ,  $L = 1\mu H$ , unless otherwise noted. Typical values are at  $T_A = 25^{\circ}C$ ,  $V_{IN} = 3.6V$ .

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
<b>Power Supplies</b>						
$I_Q$	Quiescent Current	Device is not switching, $EN = V_{IN}$		16		$\mu A$
		Device is switching, $EN = V_{IN}$		18	25	$\mu A$
$I_{(SD)}$	Shutdown Supply Current	$V_{IN} = 3.6V$ , $EN = GND$		0.05	1.00	$\mu A$
$V_{UVLO}$	Under-Voltage Lockout Threshold	Rising Edge	1.8		2.1	V
		Falling Edge	1.75		1.95	V
$V_{(ENH)}$	Enable HIGH-Level Input Voltage		1.2			V
$V_{(ENL)}$	Enable LOW-Level Input Voltage				0.4	V
$I_{(EN)}$	Enable Input Leakage Current	$EN = V_{IN}$ or GND		0.01	1.00	$\mu A$
<b>Oscillator</b>						
$f_{OSC}$	Oscillator Frequency		2.5	3.0	3.5	MHz
<b>Regulation</b>						
$V_O$	Output Voltage Accuracy	$I_{LOAD} = 0$ to 600mA	1.775	1.820	1.865	V
		CCM	1.784	1.820	1.856	V
$t_{SS}$	Soft-Start	$EN = 0 \rightarrow 1$			300	$\mu s$
<b>Output Driver</b>						
$R_{DS(on)}$	PMOS On Resistance	$V_{IN} = V_{GS} = 3.6V$		180		$m\Omega$
	NMOS On Resistance	$V_{IN} = V_{GS} = 3.6V$		170		$m\Omega$
$I_{LIM}$	PMOS Peak Current Limit	Open-Loop <sup>(2)</sup>	650	800	900	mA
$T_{TSD}$	Thermal Shutdown	CCM Only		150		$^{\circ}C$
$T_{HYS}$	Thermal Shutdown Hysteresis			20		$^{\circ}C$

### Note:

- The Electrical Characteristics table reflects open-loop data. Refer to Operation Description and Typical Characteristic for closed-loop data.

## Operation Description

The FAN5350 is a step-down switching voltage regulator that delivers a fixed 1.82V from an input voltage supply of 2.7V to 5.5V. Using a proprietary architecture with synchronous rectification, the FAN5350 is capable of delivering 600mA at over 90% efficiency, while maintaining a light load efficiency of over 80% at load currents as low as 1mA. The regulator operates at a nominal frequency of 3MHz at full load, which reduces the value of the external components to 1 $\mu$ H for the output inductor and 4.7 $\mu$ F for the output capacitor.

## Control Scheme

The FAN5350 uses a proprietary non-linear, fixed-frequency PWM modulator to deliver a fast load transient response, while maintaining a constant switching frequency over a wide range of operating conditions. The regulator performance is independent of the output capacitor ESR, allowing for the use of ceramic output capacitors. Although this type of operation normally results in a switching frequency that varies with input voltage and load current, an internal frequency loop holds the switching frequency constant over a large range of input voltages and load currents.

For very light loads, the FAN5350 operates in discontinuous current (DCM) single-pulse PFM mode, which produces low output ripple compared with other PFM architectures. Transition between PWM and PFM is seamless, with a glitch of less than 14mV at  $V_{OUT}$  during the transition between DCM and CCM modes.

Combined with exceptional transient response characteristics, the very low quiescent current of the controller (<16 $\mu$ A) maintains high efficiency, even at very light loads, while preserving fast transient response for applications requiring very tight output regulation.

## Enable and Soft Start

Maintaining the EN pin LOW keeps the FAN5350 in non-switching mode in which all circuits are off and the part draws ~50nA of current. Increasing EN above its threshold voltage activates the part and starts the soft-start cycle. During soft start, the current limit is increased in discrete steps so that the inductor current is increased in a controlled manner. This minimizes any large surge currents on the input and prevents any overshoot of the output voltage.

## Under-Voltage Lockout

When EN is high, the under-voltage lock-out keeps the part from operating until the input supply voltage rises high enough to properly operate. This ensures no misbehavior of the regulator during start-up or shutdown.

## Current Limiting

A heavy load or short circuit on the output causes the current in the inductor to increase until a maximum current threshold is reached in the high-side switch. Upon reaching this point, the high-side switch turns off, preventing high currents from causing damage.

The peak current limit shown in Figure 16,  $I_{LIM(PK)}$  is slightly higher than the open-loop tested current limit,  $I_{LIM(OL)}$ , in the Electrical Characteristics table. This is primarily due to the effect of propagation delays of the IC current limit comparator.

## Thermal Shutdown

When the die temperature increases, due to a high load condition and/or a high ambient temperature, the output switching is disabled until the temperature on the die has fallen sufficiently. The junction temperature at which the thermal shutdown activates is nominally 150°C with a 20°C hysteresis.



## Applications Information

### Selecting the Inductor

The output inductor must meet both the required inductance and the energy handling capability of the application.

The inductor value affects the average current limit, the PWM-to-PFM transition point, the output voltage ripple, and the efficiency.

The ripple current ( $\Delta I$ ) of the regulator is:

$$\Delta I \approx \frac{V_{OUT}}{V_{IN}} \cdot \left( \frac{V_{IN} - V_{OUT}}{L \cdot F_{SW}} \right) \quad (1)$$

The maximum average load current,  $I_{MAX(Load)}$  is related to the peak current limit,  $I_{LIM(PK)}$  (see figure 17) by the ripple current:

$$I_{MAX(Load)} = I_{LIM(PK)} - \frac{\Delta I}{2} \quad (2)$$

The transition between PFM and PWM operation is determined by the point at which the inductor valley current crosses zero. The regulator DC current when the inductor current crosses zero,  $I_{DCM}$ , is:

$$I_{DCM} = \frac{\Delta I}{2} \quad (3)$$

The FAN5350 is optimized for operation with  $L=1\mu H$ , but is stable with inductances ranging from 700nH to 3.0 $\mu H$ . The inductor should be rated to maintain at least 80% of its value at  $I_{LIM(PK)}$ .

Efficiency is affected by the inductor DCR and inductance value. Decreasing the inductor value for a given physical size typically decreases the DCR; but since  $\Delta I$  increases, the RMS current increases, as do the core and skin effect losses.

$$I_{RMS} = \sqrt{I_{OUT(DC)}^2 + \frac{\Delta I^2}{12}} \quad (4)$$

The increased RMS current produces higher losses through the  $R_{DS(ON)}$  of the IC MOSFETs as well as the inductor ESR.

Increasing the inductor value produces lower RMS currents, but degrades transient response. For a given physical inductor size, increased inductance usually results in an inductor with lower saturation current.

Table 1 shows the effects of inductance higher or lower than the recommended 1 $\mu H$  on regulator performance.

### Output Capacitor

Table 2 suggests 0603 capacitors. 0805 capacitors may further improve performance in that the effective capacitance is higher and ESL is lower than 0603. This improves the transient response and output ripple.

Increasing  $C_{OUT}$  has no effect on loop stability and can therefore be increased to reduce output voltage ripple or to improve transient response. Output voltage ripple,  $\Delta V_{OUT}$ , is:

$$\Delta V_{OUT} = \Delta I \cdot \left( \frac{1}{8 \cdot C_{OUT} \cdot F_{SW}} + ESR \right) \quad (5)$$

### Input Capacitor

The 4.7 $\mu F$  ceramic input capacitor should be placed as close as possible between the VIN pin and GND to minimize the parasitic inductance. If a long wire is used to bring power to the IC, additional “bulk” capacitance (electrolytic or tantalum) should be placed between  $C_{IN}$  and the power source lead to reduce ringing that can occur between the inductance of the power source leads and  $C_{IN}$ .

**Table 1. Effects of changes in inductor value (from 1 $\mu H$  recommended value) on regulator performance**

Inductor Value	$I_{MAX(Load)}$ EQ. 2	$I_{LIM(PK)}$	$\Delta V_{OUT}$ EQ. 5	Transient Response
Increase	Increase	Decrease	Decrease	Degraded
Decrease	Decrease	Increase	Increase	Improved

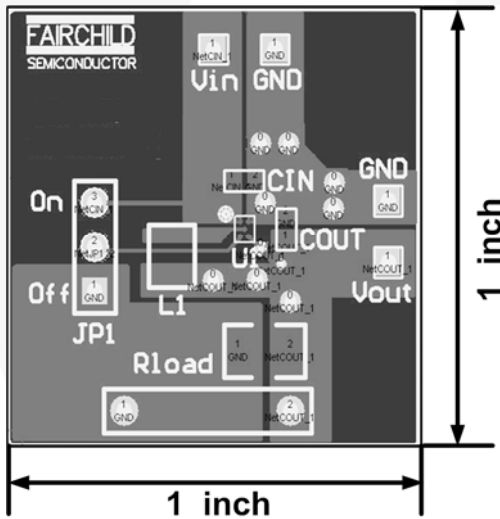
## PCB Layout Guidelines

For the bill of materials of the FAN5350 evaluation board, see Table 1. There are only three external components: the inductor and the input and output capacitors. For any buck switcher IC, including the FAN5350, it is always important to place a low-ESR input capacitor very close to the IC, as shown in Figure 7. That ensures good input decoupling, which helps reduce the noise appearing at the output terminals and

ensures that the control sections of the IC do not behave erratically due to excessive noise. This reduces switching cycle jitter and ensures good overall performance. It is not considered critical to place either the inductor or the output capacitor very close to the IC. There is some flexibility in moving these two components further away from the IC.

**Table 2. FAN5350 Evaluation Board Bill of Materials (optional parts are installed by request only)**

Description		Qty.	Ref.	Vendor	Part Number
Inductor	1.2 $\mu$ H, 1.8A, 55m $\Omega$	1	L1	TOKO	1117AS-1R2M
	1.3 $\mu$ H, 1.2A, 90m $\Omega$			FDK	MIPSA2520D1R0
	1.5 $\mu$ H, 1.3A			Taiyo Yuden	CBC3225T15MR
Capacitor 4.7 $\mu$ F, $\pm$ 10%, 6.3V, X5R, 0603		2	C <sub>IN</sub> , C <sub>OUT</sub>	MURATA	GRM39 X5R 475K 6.3
IC DC/DC Regulator in CSP, 5 bumps		1	U1	Fairchild	FAN5350UCX
Load Resistor (Optional)		1	R <sub>LOAD</sub>	Any	



**Figure 7. The FAN5350 Evaluation Board PCB (CSP)**

## Feedback Loop

One key advantage of the non-linear architecture is that there is no traditional feedback loop. The loop response to changes in  $V_{OUT}$  is essentially instantaneous, which explains its extraordinary transient response. The absence of a traditional, high-gain compensated linear loop means that the FAN5350 is inherently stable over a wide range of  $L_{OUT}$  and  $C_{OUT}$ .

$L_{OUT}$  can be reduced further for a given application, provided it is confirmed that the calculated peak current for the required maximum load current is less than the minimum of the closed-loop current limit. The advantage is that this generally leads to improved transient response, since a small inductance allows for a much faster increase in current to cope with any sudden load demand.

The inductor can be increased to 2.2 $\mu$ H; but, for the same reason, the transient response gets slightly degraded. In that case, increasing the output capacitor to 10 $\mu$ F helps significantly.

## Typical Performance Characteristics

$V_{IN} = 3.6V$ ,  $T_A = 25^\circ C$ ,  $V_{EN} = V_{IN}$ , according to the circuit in Figure 1 or Figure 2, unless otherwise specified.

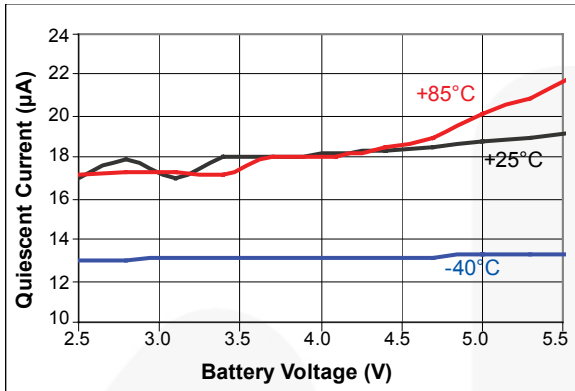


Figure 8. Quiescent Current vs. Battery Voltage

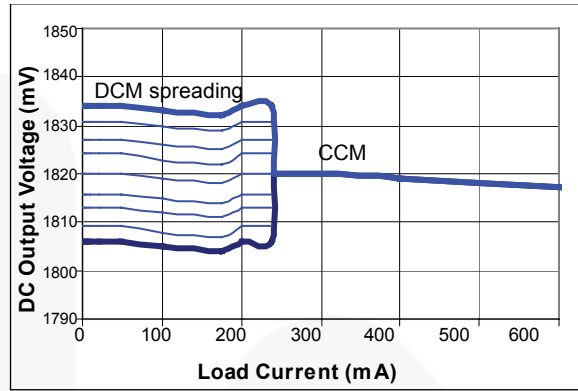


Figure 9. Load Regulation, Increasing Load

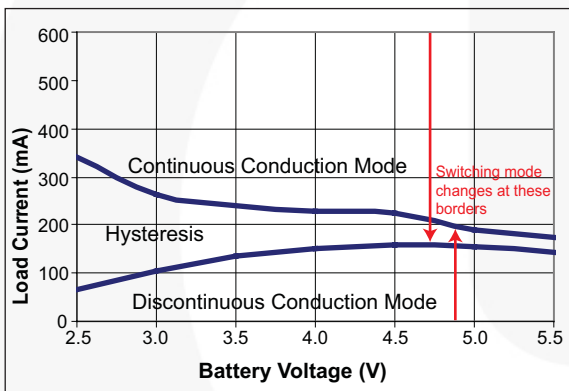


Figure 10. Switch Mode Operating Areas

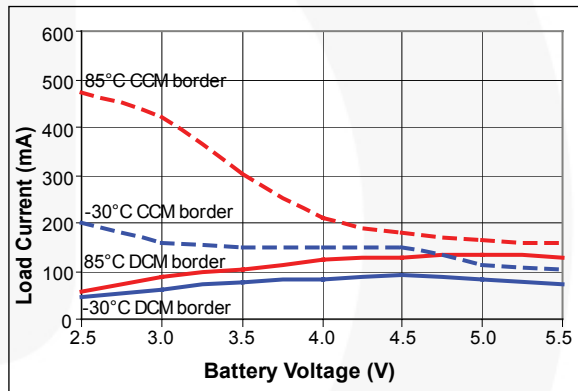


Figure 11. Switch Mode Over Temperature

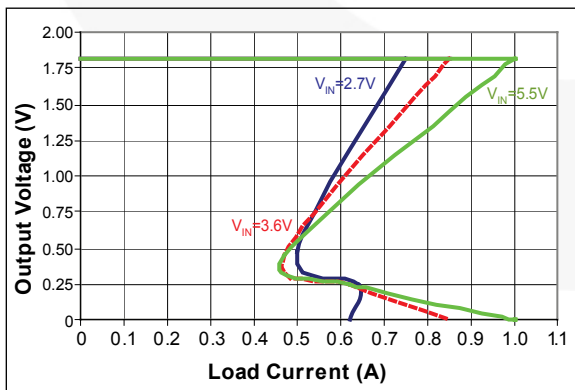


Figure 12. DC Current Voltage Output Characteristics

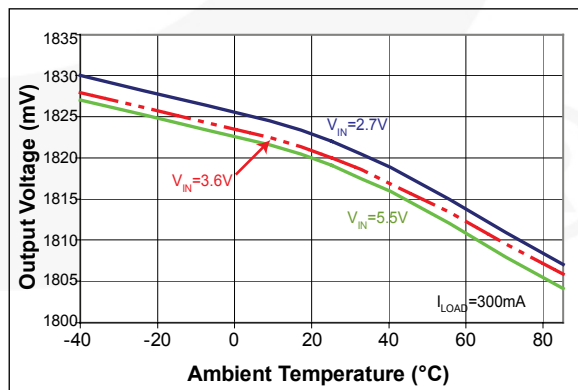


Figure 13. Output Voltage vs. Temperature

### Typical Performance Characteristics (Continued)

$V_{IN} = 3.6V$ ,  $T_A = 25^\circ C$ ,  $V_{EN} = V_{IN}$ , according to the circuit in Figure 1 or Figure 2, unless otherwise specified.

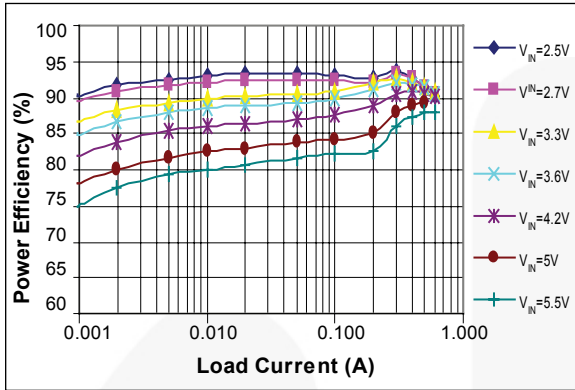


Figure 14. Power Efficiency vs. Load Current

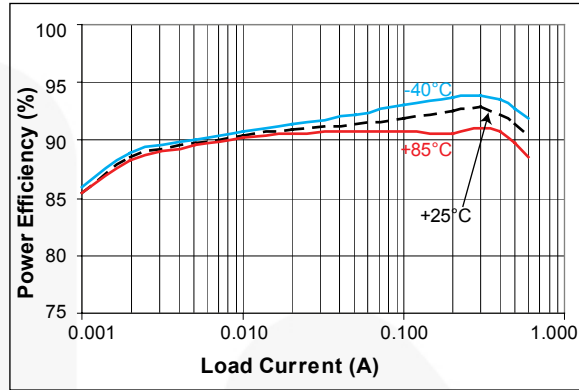


Figure 15. Power Efficiency Over Temperature Range

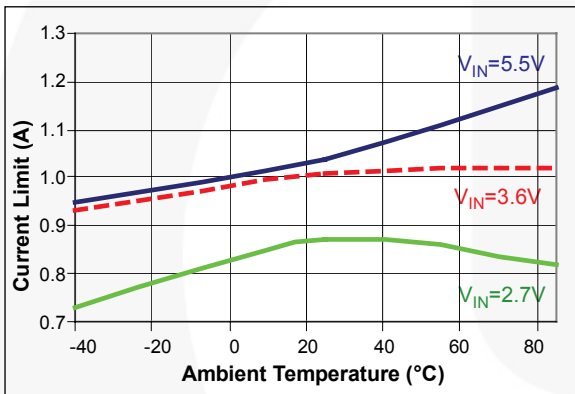


Figure 16. PMOS Current Limit in Closed Loop

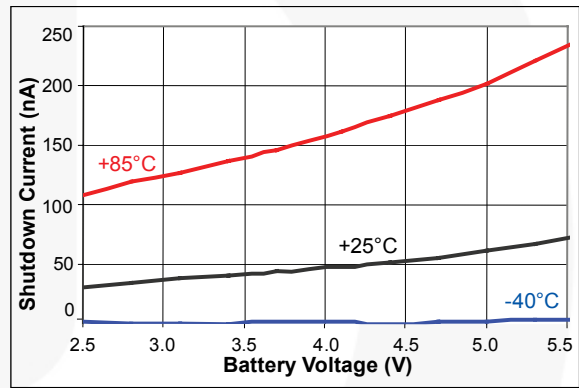


Figure 17. Shutdown Supply Current vs. Battery Voltage

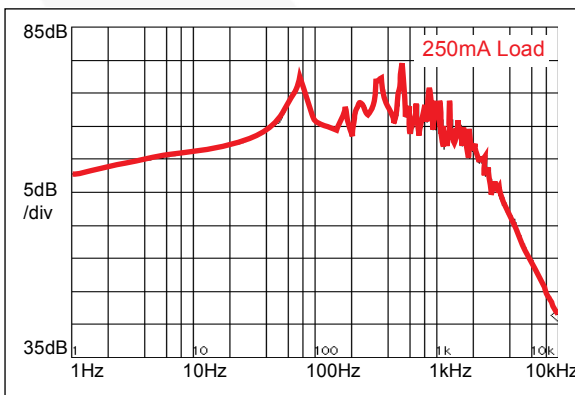


Figure 18. Power Supply Rejection Ratio in CCM

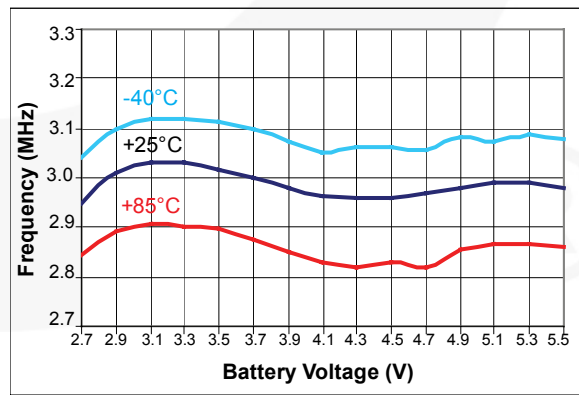
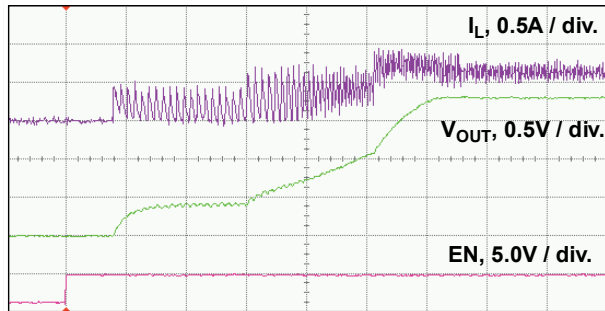


Figure 19. Switching Frequency in CCM

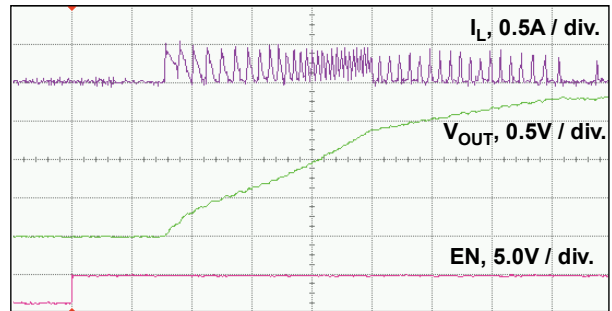
### Typical Performance Characteristics (Continued)

$V_{IN} = 3.6V$ ,  $T_A = 25^\circ C$ ,  $V_{EN} = V_{IN}$ , according to the circuit in Figure 1 or Figure 2, unless otherwise specified.



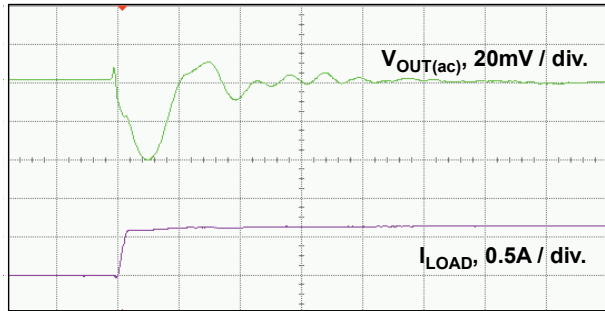
H scale: 20µs / div.

Figure 20. Startup, Full Load



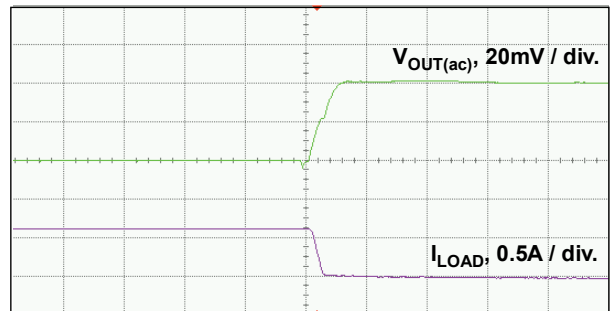
H scale: 10µs / div.

Figure 21. Startup, No Load



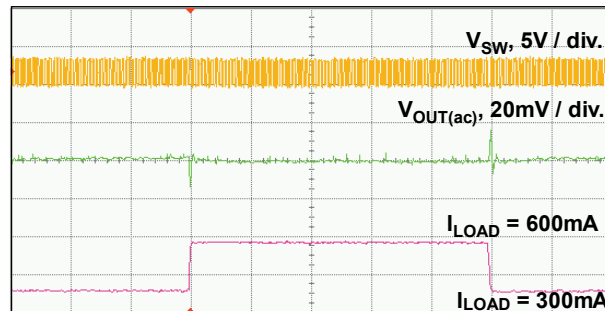
H scale: 1µs / div.

Figure 22. Fast Load Transient, No Load to Full Load



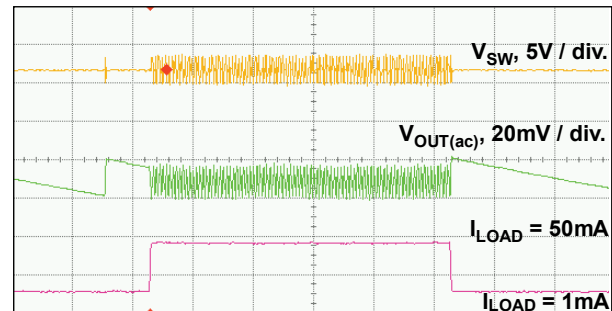
H scale: 1µs / div.

Figure 23. Fast Load Transient, Full Load to No Load



H scale: 20µs / div.

Figure 24. Fast Load Transient in CCM

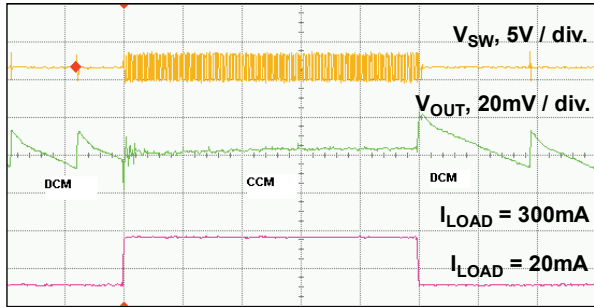


H scale: 20µs / div.

Figure 25. Fast Load Transient in DCM

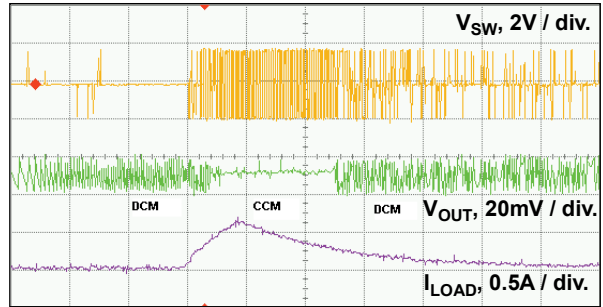
### Typical Performance Characteristics (Continued)

$V_{IN} = 3.6V$ ,  $T_A = 25^\circ C$ ,  $V_{EN} = V_{IN}$ , according to the circuit in Figure 1 or Figure 2, unless otherwise specified.



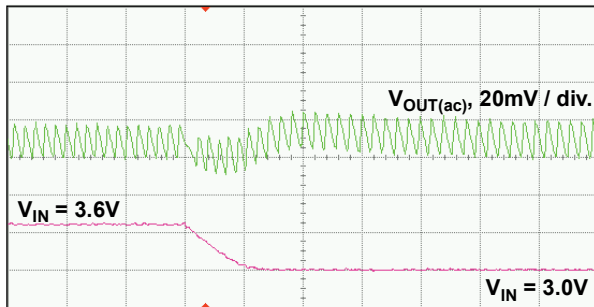
H scale:  $20\mu s$  / div.

Figure 26. Fast Load Transient DCM – CCM – DCM



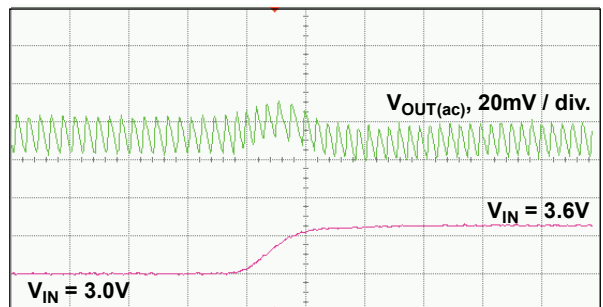
H scale: 2ms / div.

Figure 27. Slow Load Transient DCM – CCM – DCM



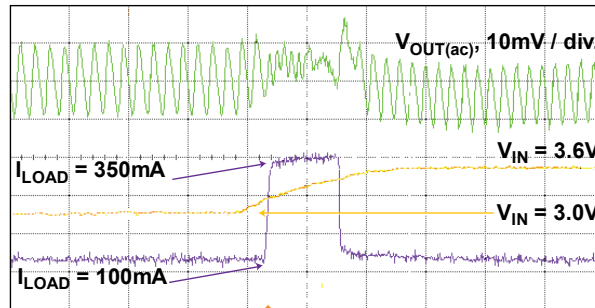
H scale:  $10\mu s$  / div.

Figure 28. Line Transient, 600mV, 50mA Load



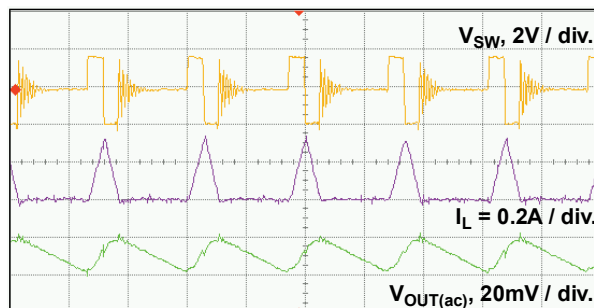
H scale:  $10\mu s$  / div.

Figure 29. Line Transient, 600mV, 50mA Load



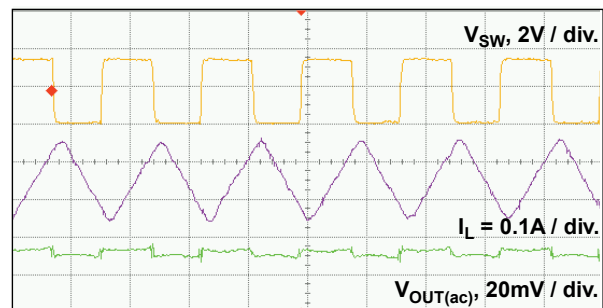
H scale:  $5\mu s$  / div.

Figure 30. Combined Line (600mV) and Load (100mA to 350mA) Transient Response



H scale:  $1\mu s$  / div.

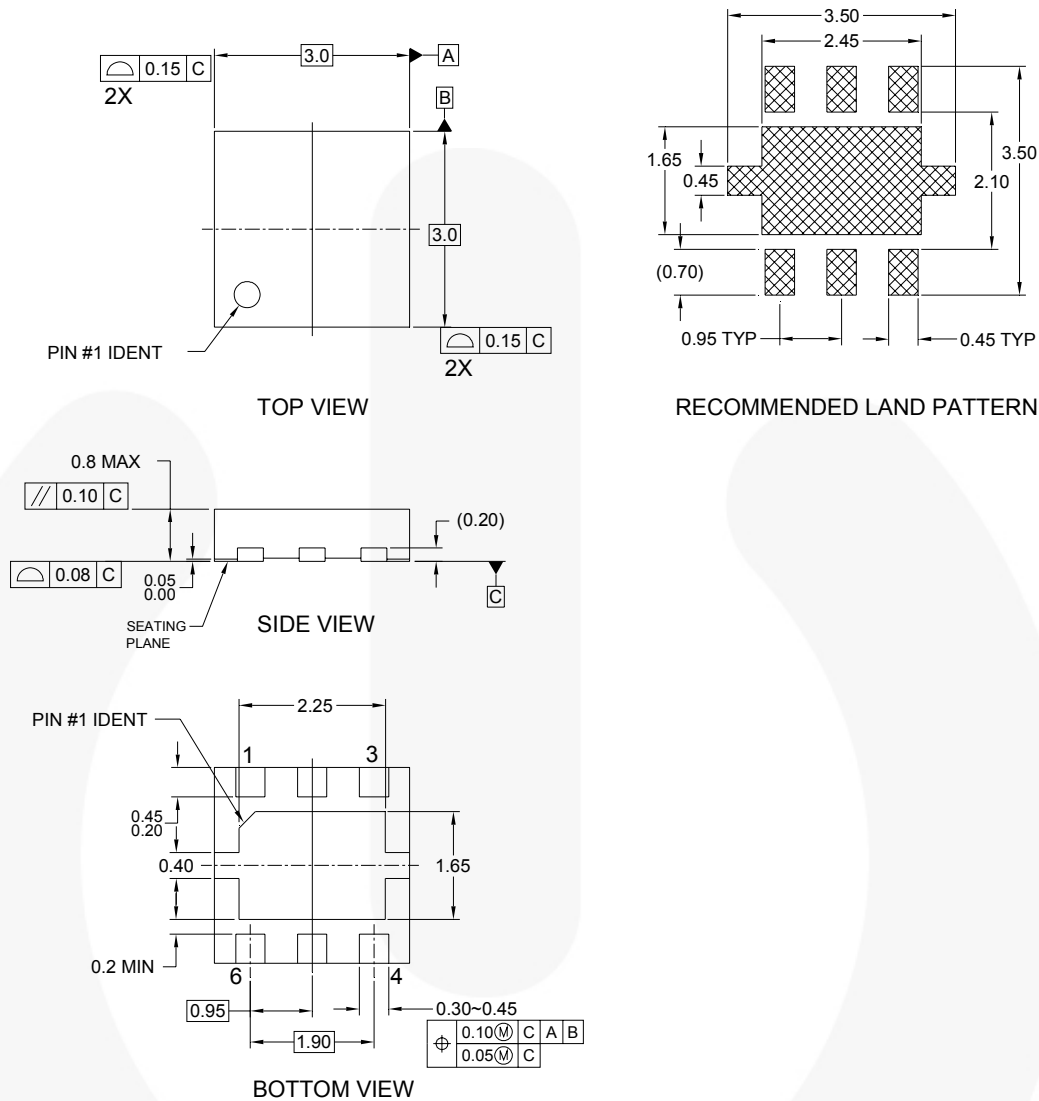
Figure 31. Typical Waveforms in DCM, 50mA Load



H scale: 200ns / div.

Figure 32. Typical Waveforms in CCM, 150mA Load

## Physical Dimensions



### NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-229, VARIATION WEEA, DATED 11/2001 EXCEPT FOR DAP EXTENSION TABS
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

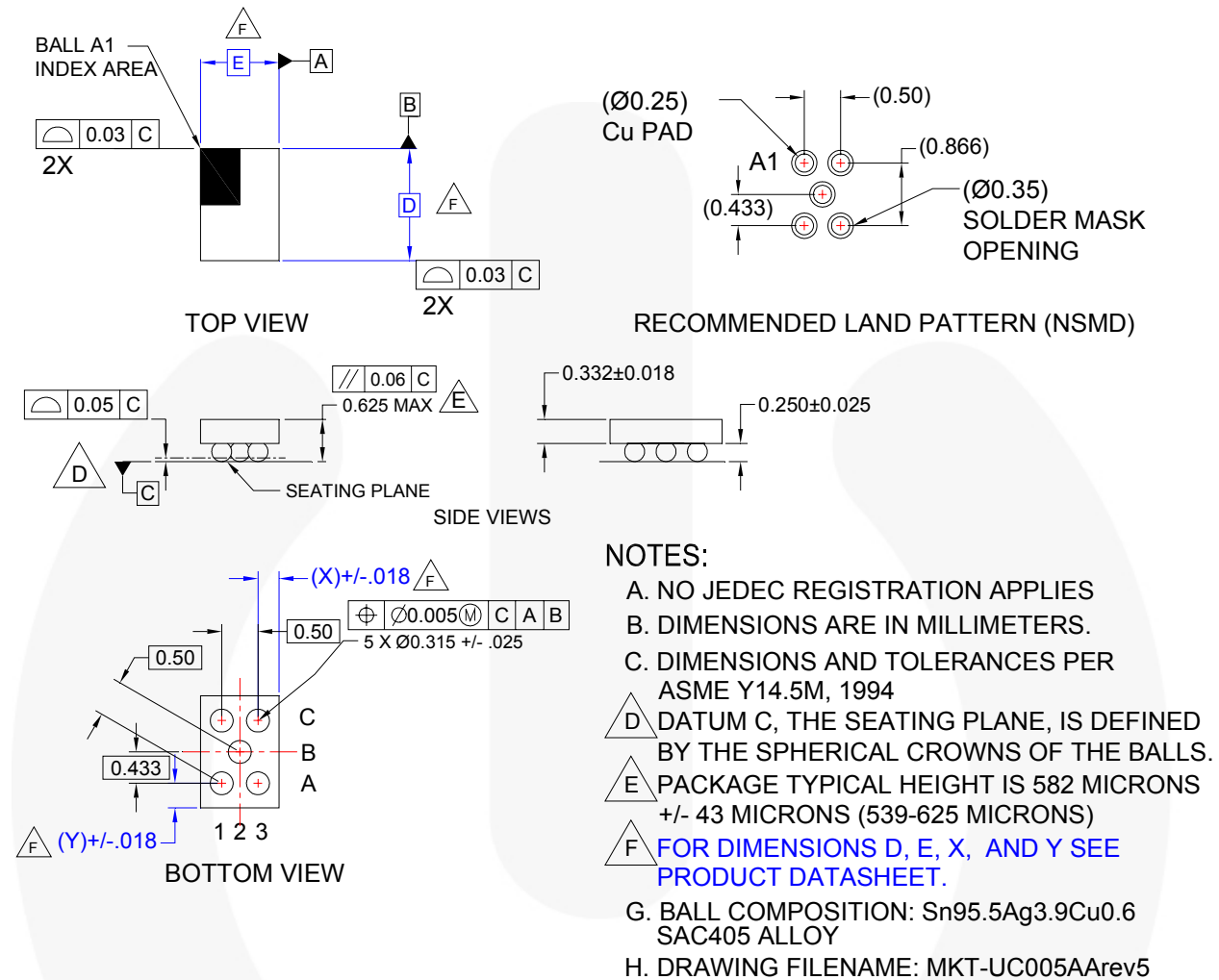
MLP06FrevA

**Figure 33. 6-Lead Molded Leadless Package (MLP)**

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<http://www.fairchildsemi.com/packaging/>.

### Physical Dimensions (Continued)



### Product Specific Dimensions

Product	D	E	X	Y
FAN5350UCX	1.350 +/- 0.040	0.980 +/- 0.040	0.242	0.244

**Figure 34. 5-Bump Wafer-Level Chip-Scale Package (WLCSP)**

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| Build it Now™            | Green FPS™                          | Programmable Active Droop™            | TinyBoost™           |
| CorePLUS™                | Green FPS™ e-Series™                | QFET®                                 | TinyBuck™            |
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| CTL™                     | IntelliMAX™                         | RapidConfigure™                       | TINYOPTO™            |
| Current Transfer Logic™  | ISOPLANAR™                          | TM                                    | TinyPower™           |
| DEUXPEED®                | MegaBuck™                           | Saving our world, 1mW/W/KW at a time™ | TinyPVM™             |
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